

# BIGDL: A DISTRIBUTED DEEP LEARNING LIBRARY ON SPARK

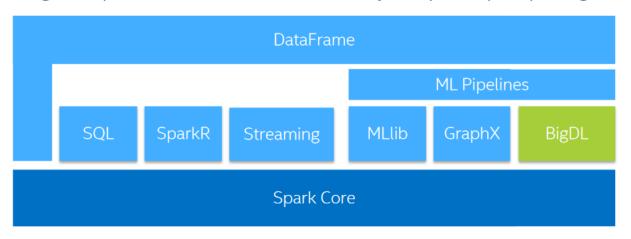
Yiheng Wang

Big Data Technology Team, Software and Service Group, Intel

## What is BigDL?

#### BigDL is a distributed deep learning library for Apache Spark\*

BigDL: implemented as a standalone library on Spark (Spark package)



# WHY BIGDL?

#### Production ML/DL system is **Complex**

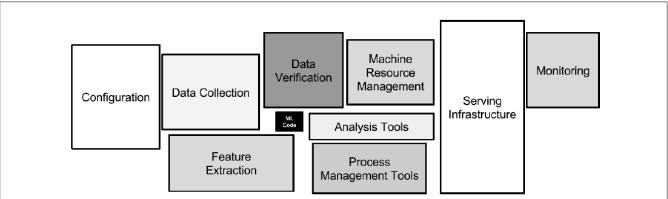
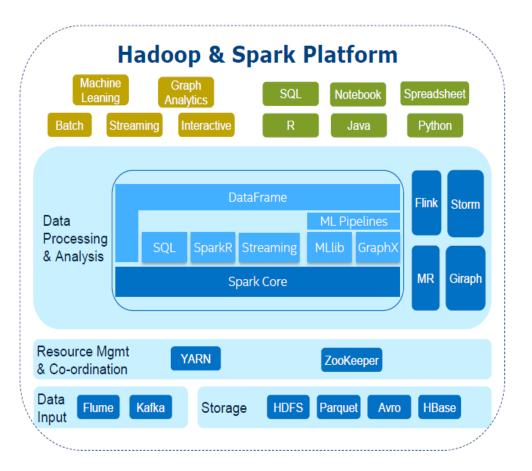


Figure 1: Only a small fraction of real-world ML systems is composed of the ML code, as shown by the small black box in the middle. The required surrounding infrastructure is vast and complex.

"Hidden Technical Debt in Machine Learning Systems", Google, NIPS 2015 Paper

## How to Run Deep Learning Workloads Directly on Big Data Platform?

- Integrated with Big Data ecosystem
- Massively distributed, scale out
- Send compute to data
- Fault tolerance
- Elasticity
- Incremental scaling
- Dynamic resource sharing
- ...



#### BigDL open sourced on Dec 30, 2016

https://github.com/intel-analytics/BigDL

- Write deep learning applications as standard Spark programs
- Run on top of existing Spark or Hadoop clusters(No change to the clusters)
- Rich deep learning support
- High performance powered by Intel MKL and multi-threaded programming
- Efficient scale-out with an all-reduce communications on Spark

You may want to write your deep learning programs using BigDL if:

- Analyze "big data" using deep learning on the same Hadoop/Spark cluster where the data are stored
- Add deep learning functionalities to the Big Data (Spark) programs and/or workflow
- Leverage existing Hadoop/Spark clusters to run deep learning applications, which are dynamically shared with other workloads (e.g., ETL, data warehouse, feature engineering, classical machine learning, graph analytics, etc.)
- Making deep learning more accessible for Big Data users and data scientists, who are usually not experts for deep learning

# **BIGDL FEATURES**

#### **Tensor**

- A powerful ndarray data structure
- Generic data type
- Data manipulate / math APIs, model after torch

```
scala> import com.intel.analytics.bigdl.tensor.Tensor
import com.intel.analytics.bigdl.tensor.Tensor

scala> val tensor = Tensor[Float](2, 3)
tensor: com.intel.analytics.bigdl.tensor.Tensor[Float] =
0.0     0.0     0.0
0.0     0.0     0.0
[com.intel.analytics.bigdl.tensor.DenseTensor of size 2x3]
```

#### Layers

90+ Layers

#### Criterion

10+ loss functions

#### **Optimization**

SGD, Adagrad, LBFGS

```
scala> import com.intel.analytics.bigdl.numeric.NumericFloat // import global float tensor
import com.intel.analytics.bigdl.numeric.NumericFloat
scala> import com.intel.analytics.bigdl.nn.
import com.intel.analytics.bigdl.nn.
scala> val f = Linear(3,4) // create the module
mlp: com.intel.analytics.bigdl.nn.Linear[Float] = nn.Linear(3 -> 4)
// let's see what f's parameters were initialized to. ('nn' always inits to something reason
scala> f.weight
res5: com.intel.analytics.bigdl.tensor.Tensor[Float] =
-0.008662592
                0.543819
                                -0.028795477
-0.30469555
                -0.3909278
                                -0.10871882
0.114964925
               0.1411745
                                0.35646403
-0.16590376
                -0.19962183
                                -0.18782845
[com.intel.analytics.bigdl.tensor.DenseTensor of size 4x3]
```

#### Build a simple model

```
scala> val g = Sum()
g: com.intel.analytics.bigdl.nn.Sum[Float] = nn.Sum

scala> val mlp = Sequential().add(f).add(g)
mlp: com.intel.analytics.bigdl.nn.Sequential[Float] =
nn.Sequential {
  [input -> (1) -> (2) -> output]
  (1): nn.Linear(3 -> 4)
  (2): nn.Sum
}
```

## BigDL Features - A full example

```
val model = Sequential()
  .add(SpatialConvolution(3, 64, 11, 11, 4, 4, 2, 2, 1))
  .add(ReLU(true))
  .add(SpatialMaxPooling(3, 3, 2, 2))
  .add(SpatialConvolution(64, 192, 5, 5, 1, 1, 2, 2))
  .add(ReLU(true))
  .add(SpatialMaxPooling(3, 3, 2, 2))
  .add(SpatialConvolution(192, 384, 3, 3, 1, 1, 1, 1))
  .add(ReLU(true))
  .add(SpatialConvolution(384, 256, 3, 3, 1, 1, 1, 1))
  .add(ReLU(true))
  .add(SpatialConvolution(256, 256, 3, 3, 1, 1, 1, 1))
  .add(ReLU(true))
  .add(SpatialMaxPooling(3, 3, 2, 2))
  .add(View(256 * 6 * 6))
  .add(Linear(256 * 6 * 6, 4096))
  .add(ReLU(true))
  .add(Dropout(0.5))
  .add(Linear(4096, 4096))
  .add(ReLU(true))
  .add(Dropout(0.5))
  .add(Linear(4096, 1000))
  .add(LogSoftMax())
```

```
val optimizer = Optimizer(
  model = model,
  dataset = trainSet,
  criterion = new ClassNLLCriterion[Float]()
optimizer
  .setState(state)
  .setValidation(Trigger.severalIteration(620).
   valSet, Array(new Top1Accuracy[Float], new Top5Accuracy[Float]))
  .setEndWhen(Trigger.maxIteration(62000))
  .optimize()
```

#### Start with tutorials

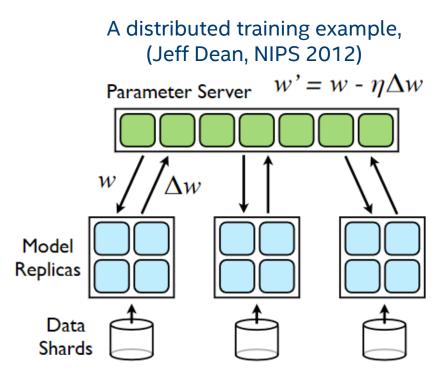
https://github.com/intel-analytics/BigDL/wiki/Tutorials



- 2. Text Classification working with Spark RDD transformations
- 3. Image Classification working with Spark DataFrame and ML pipeline

#### **Distributed Training**

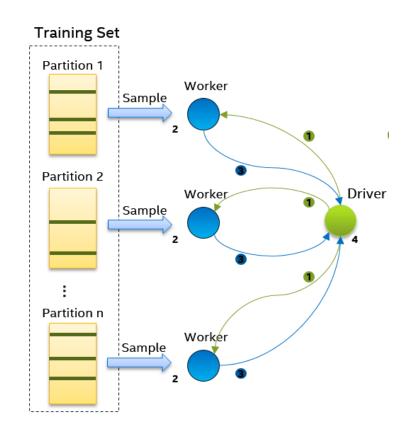
- Model Parallelism
- Data Parallelism



"Canonical" implementation on Apache Spark

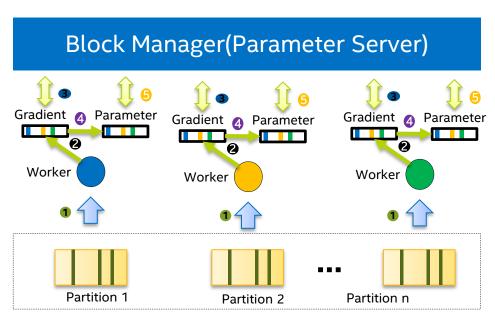
Driver become the bottleneck

- RDD.reduce / aggregate
- RDD.treeAggregate (shuffle)



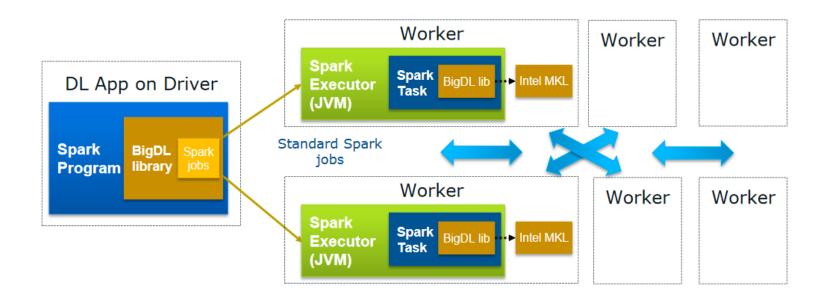
#### BigDL distributed training highlight

- Implement an P2P All Reduce Algorithm on Apache Spark
- Spark block manager as parameter server (handle different APIs of Spark 1.x/2.x)
- Compress float32 parameter to float16 parameter



**Training Set** 

#### Train deep learning model on Apache Spark\*



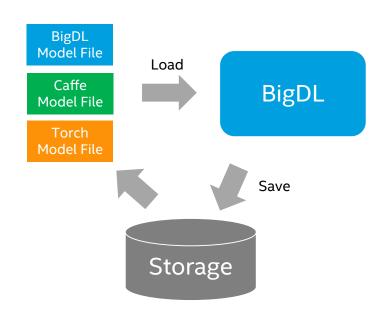
Distributed training prefer large batch, need tune hyper parameter

An example of Googlenet\_v1 on ImageNet (batchsize = 1500+)

- learningRate -> 0.0896
- weightDecy -> 0.0001
- Momentum -> 0.9
- learningRateSchedule -> Poly(power = 0.5, iteration = 62000)

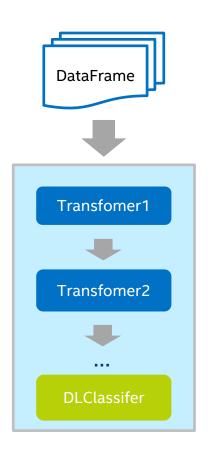
- Model Snapshot
  - Useful in a long training
  - Used in inference later
  - Share your model with others
  - Fine-tune the model

- Load Caffe/Torch Model
  - Leverage existed trained model



#### Integrate with Spark-ML Pipeline

- Wrapper with Spark ML Transformer
- Plug into Spark ML pipeline
- Support 1.5/1.6/2.0



BigDL provide examples to help developer play with bigdl and start with popular models.

https://github.com/intel-analytics/BigDL/wiki/Examples

#### Models (Train and Inference Example Code):

LeNet, Inception, VGG, ResNet, RNN, Auto-encoder

#### Examples:

- Text Classification
- Image Classification
- Load Torch/Caffe model

#### Examples

Shiging Fan edited this page 28 days ago · 4 revisions

BigDL provides many popular neural network models and deep learning examples for Apache Spark, including:

- Models
  - LeNet: it demonstrates how to use BigDL to train and evaluate the LeNet-5 network on MNIST data.
- Inception: it demonstrates how to use BigDL to train and evaluate Inception v1 and Inception v2 architecture on the ImageNet data.
- VGG: it demonstrates how to use BigDL to train and evaluate a VGG-like network on CIFAR-10 data.
- ResNet: it demonstrates how to use BigDL to train and evaluate the ResNet architecture on CIEAR-10 data
- RNN: it demonstrates how to use BigDL to build and train a simple recurrent neural network (RNN) for language model.
- Auto-encoder: it demonstrates how to use BigDL to build and train a basic fully-connected autoencoder using MNIST data.
- Examples
- text\_classification: it demonstrates how to use BigDL to build a text classifier using a simple convolutional neural network (CNN) model.
- image\_classification: it demonstrates how to load a BigDL or Torch model trained on ImageNet data (e.g., Inception or ResNet), and then applies the loaded model to classify the contents of a set of images in Spark ML pipeline.
- load\_model: it demonstrates how to use BigDL to load a pre-trained Torch or Caffe model into Spark program for prediction.

BigDL Out-of-box run scripts on AWS

https://github.com/intel-analytics/BigDL/wiki/Running-on-EC2





Model on Data Set	Top-1 Accuracy
LeNet5 on MNIST	99%
Vgg on Cifar10	90%
AlexNet OWT on ImageNet	56%
GoogleNetV1 on ImageNet	68%

- Single node Xeon performance
  - Benchmarked best on Xeon E5-26XX v3 or E5-26XX v4
  - Orders of magnitude speedup vs. out-of-box open source Caffe, Torch or TensorFlow

- Scaling-out
  - Efficiently scale out to several 10s of Xeon servers on Spark to distributed train some deep learning model on ImageNet dataset

For more complete information about performance and benchmark results, visit www.intel.com/benchmarks

# **BIGDL-USE CASE**

#### Fraud Transaction Detection

Fraud transaction detection is very import to finance companies. A good fraud detection solution can save a lot of money.

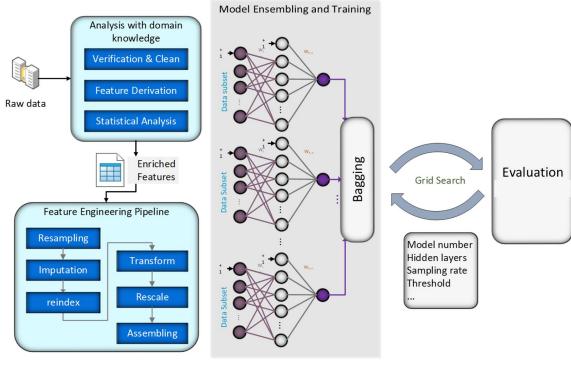
#### ML solution challenge

- Data cleaning
- Feature engineering
- Unbalanced data
- Hyper parameter



#### Fraud Transaction Detection

- History data is stored on Hive
- Easily data preprocess/cleaning with Spark-SQL
- Spark ML pipeline for complex feature engineering
- Under sample + Bagging solve unbalance problem
- Grid search for hyper parameter tunning



#### Product Defect Detection and Classification

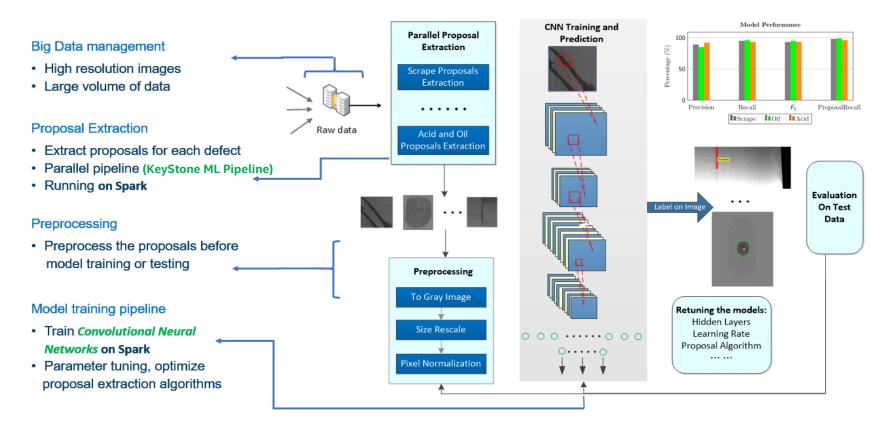
#### Data source

Cameras installed on manufactory pipeline

#### Task

- Detect defect from the photos
- Classify the defect

#### **Product Defect Detection and Classification**



## **BIGDL ON GITHUB**

https://github.com/intel-analytics/BigDL

## Feature Requests

#### Some feature requests from community

- Mac support
- Python
- LSTM
- ...

Feedback or feature requests or PRs are welcome

## Community

Mail List

bigdl-user-group+subscribe@googlegroups.com

Report bugs and feature request

https://github.com/intel-analytics/BigDL/issues

## **BigDL Contacts**

Radhika Rangarajan (Spark Sr. Program Manager, Big Data Technologies, Intel)

Jason Dai (Sr. PE and Chief Architect, Big Data Technologies, Intel)

Ziya Ma (VP, SSG and Director, Big data Technologies, Intel)

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